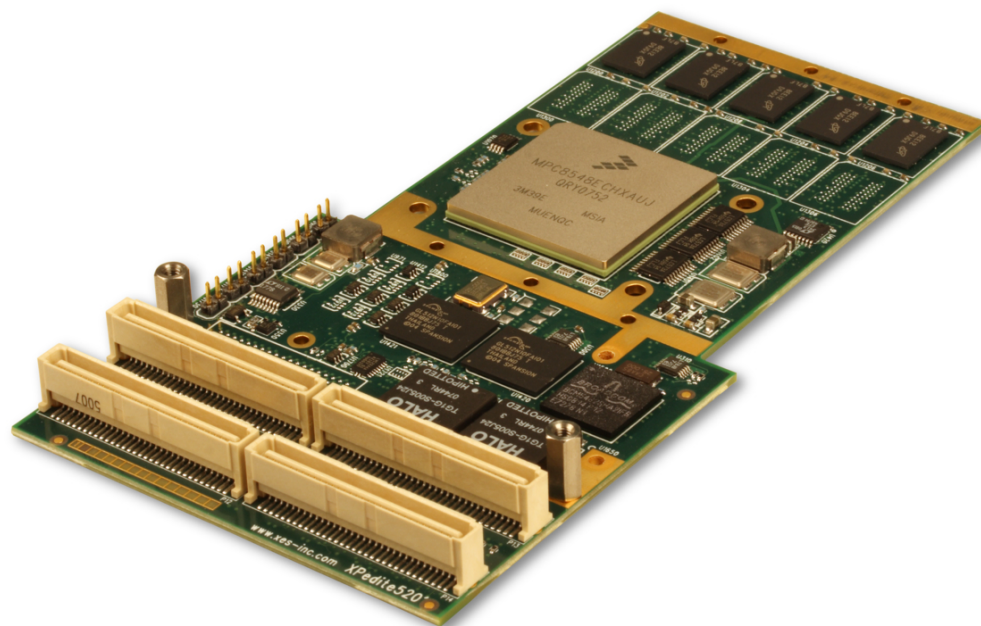


XPedite5201

Freescale MPC8548E PowerQUICC™ III Processor-Based Conduction-Cooled PMC/XMC Module

- ▶ Freescale MPC 8548E PowerQUICC™ III processor at up to 1.333 GHz
- ▶ Conduction-cooled PMC/XMC module
- ▶ 133-MHz, 64-bit PCI-X
- ▶ x8 PCI Express
- ▶ Up to 4 GB DDR2-533 SDRAM
- ▶ 512-KB L2 cache
- ▶ Double-precision FPU
- ▶ Up to 256 MB of soldered NOR flash
- ▶ Up to 4 GB of NAND flash
- ▶ Wind River VxWorks BSP
- ▶ QNX Neutrino BSP
- ▶ Green Hills INTEGRITY BSP
- ▶ Linux LSP



XPedite5201

The XPedite5201 is a high-performance, conduction-cooled Processor PCI Mezzanine Card (PrPMC) / XMC featuring the Freescale MPC8548E PowerQUICC III processor running at up to 1.333 GHz. The on-board PowerQUICC III provides integrated 64-bit PCI-X, DDR2-400/533 SDRAM, PCI Express, and two Gigabit Ethernet interfaces, making the XPedite5201 an optimal solution for communications processing and general computing applications alike.

When used as an XMC (VITA 42) module, the x8 PCI Express interface can be used, in parallel or in substitution of the PCI-X interface. With software supplied by Extreme Engineering Solutions, the XPedite5201 can be installed on standard VME and CompactPCI (cPCI) platforms as well as custom motherboards that support PMC sites.

The XPedite5201 provides two Gigabit Ethernet interfaces via the P14 backplane connector.

X-ES

Extreme Engineering Solutions

...Always Fast

Extreme Engineering Solutions

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 sales@xes-inc.com • <http://www.xes-inc.com>

Processor

- Freescale MPC 8548E PowerQUICC III processor
- Embedded PowerPC e500 core at 1.0 to 1.333 GHz
- 3065 MIPS at 1.333 GHz
- 32 KB L1 instruction/data caches
- 512 KB L2 cache
- Double-precision floating point unit
- Integrated MMU
- DDR2-533 SDRAM interface
- x8 PCI Express
- 133-MHz, 64-bit PCI-X 1.0a interface
- Four 10/100/1000-Mbps, IEEE 802.3-compliant Ethernet controllers
- Two serial controllers
- Two I²C controllers

Memory

- 1 GB to 4 GB DDR2-533 SDRAM
- Up to 256 MB NOR flash
- 1 GB to 4 GB NAND flash
- 2 KB serial EEPROM

XMC

- x8 PCI Express (VITA 42.3)
- IPMI FRU support
- GPIO on user data

RTC

- M41T00 I²C Timekeeper
- 60-hour clock retention

Rear I/O

- Two Gigabit Ethernet ports
- Four GPIO pins
- Two RS-232 serial ports

Software Support

- Wind River VxWorks BSP
- QNX Neutrino BSP
- Green Hills INTEGRITY BSP
- Linux LSP

Physical Characteristics

- PMC/XMC conduction-cooled form factor
- Dimensions: 149 mm x 74 mm, 10-mm stacking height

Environmental Requirements

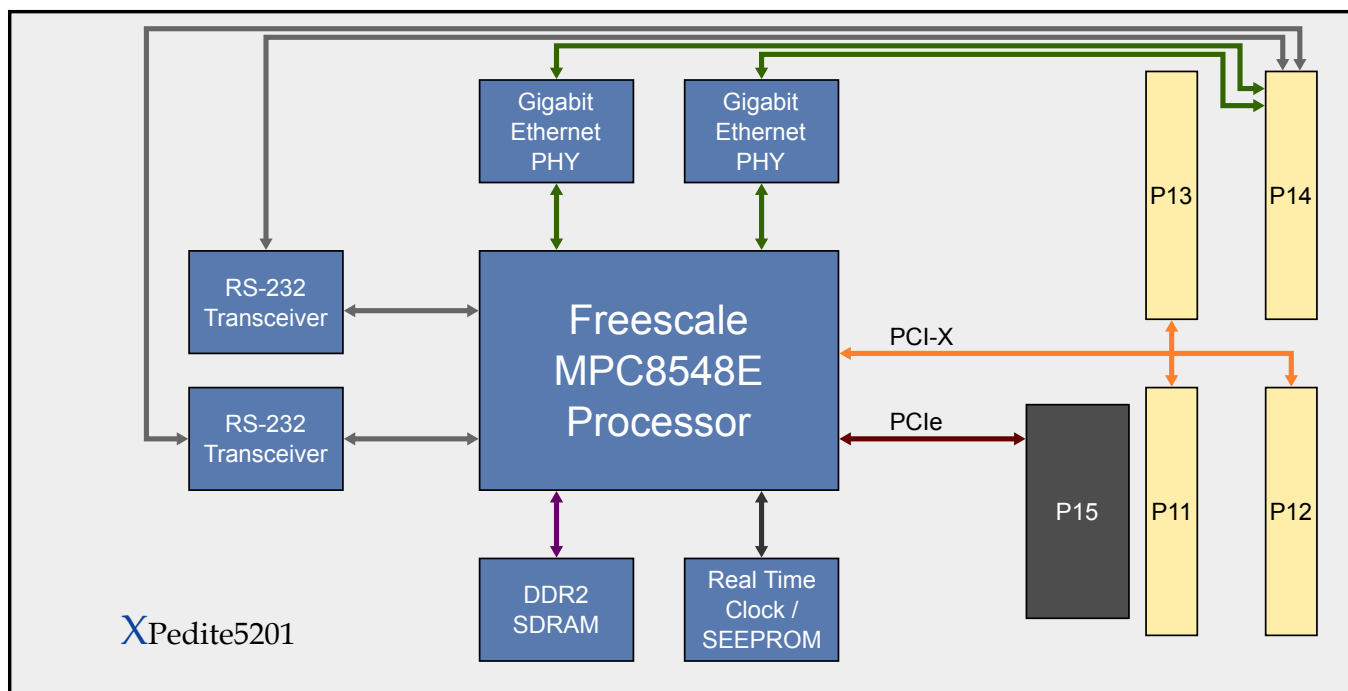
Contact factory for appropriate board configuration based on environmental requirements.

- Supported ruggedization levels (see chart below): Level 1, Level 2, Level 3, Level 4, Level 5
- Humidity: 0% to 95% non-condensing

Power Requirements

- Maximum power consumption: 13.35 W (with 1.333-GHz processor)
10.5 W (with 1-GHz processor)

Ruggedization Level	Level 1	Level 2	Level 3	Level 4	Level 5
Cooling Method	Standard Air-Cooled	Extended Air-Cooled	Rugged Air-Cooled	Conduction-Cooled	Conduction-Cooled
Operating Temperature	0 to +55 °C	0 to +65 °C	-40 to +70 °C	-40 to +70 °C	-40 to +85 °C
Vibration	0.002 g ² /Hz	0.002 g ² /Hz	0.04 g ² /Hz	0.1 g ² /Hz	0.1 g ² /Hz
Shock	20 g	20 g	40 g	40 g	40 g
Storage Temperature	-40 to +105 °C	-40 to +105 °C	-55 to +105 °C	-55 to +105 °C	-55 to +105 °C



XPedite5201



ISO 9001:2000
FM 87995